

RC19XXX, 9QXL2001X vs. LMKDB1XXX, CDCDB2000 Drop-In Replacement Guide



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ABSTRACT

Several applications using the Renesas' RC19XXX, 9QXL2001X, and TI's LMKDB1XXX, CDCDB2000 families require several vendors to supply clock buffers, also known as multi-sourcing. The compatible parts in each device family have the same pin-outs but certain differences between the designs. To certify proper operation when completing a drop-in replacement of the RC19XXX/9QXL2001X device families with the LMKDB1XXX/CDCDB2000 device family, certain customer design requirements need to be made on either hardware and or software, depending on the part. Those design requirements and the differences between the parts are highlighted in this document.

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1 Introduction

The RC19XXX/9QXL2001X device families have the same pin-out as the LMKDB1XXX/CDCDB2000 device family. This document compares all pins, features, and registers between the parts, highlighting any differences and stating any key actions required when completing a drop-in replacement. Each part comparison section contains a subsection going through the hardware changes required and another going through the software changes required.

2 RC19020 vs. LMKDB1120 Comparison

2.1 RC19020 vs. LMKDB1120 Pin Comparison

To summarize, when replacing the RC19020 with the LMKDB1120, do not leave the vPWRGD/PWRDN# pin (M6) floating and depend on the internal pulldown resistor on the LMKDB1120. Instead, drive pin M6 low or high through external controllers, or pull pin M6 low or high through external resistors.

| PIN | | | | Pin Differences between RC19020 and LMKDB1120 that Affect Drop-In Replacements | Design Requirements when Replacing the RC19020 with the LMKDB1120 |
|---------------|--------------|-----|------|--|---|
| TI NAME | RENESAS NAME | NO. | TYPE | | |
| Input | | | | | |
| CLKIN_P | CLKIN | G1 | I | No differences. | N/A. |
| CLKIN_N | CLKINb | H1 | I | | |
| Output | | | | | |
| CLK0_P | CLK0 | J1 | O | No difference | N/A. |
| CLK0_N | CLKb0 | K1 | O | | |
| CLK1_P | CLK1 | L1 | O | | |
| CLK1_N | CLKb1 | M1 | O | | |
| CLK2_P | CLK2 | M2 | O | | |
| CLK2_N | CLKb2 | M3 | O | | |
| CLK3_P | CLK3 | M4 | O | | |
| CLK3_N | CLKb3 | M5 | O | | |
| CLK4_P | CLK4 | M7 | O | | |
| CLK4_N | CLKb4 | M8 | O | | |
| CLK5_P | CLK5 | M9 | O | | |
| CLK5_N | CLKb5 | M10 | O | | |
| CLK6_P | CLK6 | M11 | O | | |
| CLK6_N | CLKb6 | M12 | O | | |
| CLK7_P | CLK7 | L12 | O | | |
| CLK7_N | CLKb7 | K12 | O | | |
| CLK8_P | CLK8 | J12 | O | | |
| CLK8_N | CLKb8 | H12 | O | | |
| CLK9_P | CLK9 | G12 | O | | |
| CLK9_N | CLKb9 | F12 | O | | |
| CLK10_P | CLK10 | D12 | O | | |
| CLK10_N | CLKb10 | C12 | O | | |
| CLK11_P | CLK11 | B12 | O | | |
| CLK11_N | CLKb11 | A12 | O | | |
| CLK12_P | CLK12 | A11 | O | | |
| CLK12_N | CLKb12 | A10 | O | | |
| CLK13_P | CLK13 | A9 | O | | |
| CLK13_N | CLKb13 | A8 | O | | |
| CLK14_P | CLK14 | A7 | O | | |
| CLK14_N | CLKb14 | A6 | O | | |
| CLK15_P | CLK15 | A5 | O | | |
| CLK15_N | CLKb15 | A4 | O | | |
| CLK16_P | CLK16 | A3 | O | | |
| CLK16_N | CLKb16 | A2 | O | | |
| CLK17_P | CLK17 | A1 | O | | |
| CLK17_N | CLKb17 | B1 | O | | |

| PIN | | | | Pin Differences between RC19020 and LMKDB1120 that Affect Drop-In Replacements | Design Requirements when Replacing the RC19020 with the LMKDB1120 |
|----------------------|----------------|-----|------|---|---|
| TI NAME | RENESAS NAME | NO. | TYPE | | |
| CLK18_P | CLK18 | C1 | O | No difference | N/A. |
| CLK18_N | CLKb18 | D1 | O | | |
| CLK19_P | CLK19 | E1 | O | | |
| CLK19_N | CLKb19 | F1 | O | | |
| Output Enable | | | | | |
| vOE0#/NC | NC | J2 | I | Completing a drop-in replacement does not require any changes on these pins. These pins are NC for both the RC19020 and the LMKDB1120 and can be left floating. LMKDB1120 offers an additional active low OE function for CLK0, CLK1, CLK2, CLK3, and CLK4. These LMKDB1120 pins have internal pulldown resistors that enable the outputs by default and can be left floating. | N/A. |
| vOE1#/NC | NC | K2 | I | | |
| vOE2#/NC | NC | L3 | I | | |
| vOE3#/NC | NC | L6 | I | | |
| vOE4#/NC | NC | L9 | I | | |
| vOE5#/SBI_IN | OEb5_SBI_IN | L8 | I | No differences | |
| vOE6#/SBI_CLK | OEb6_SBI_CLK | L10 | I | | |
| vOE7# | OEb7 | K11 | I | | |
| vOE8# | OEb8 | H11 | I | | |
| vOE9# | OEb9 | E12 | I | | |
| vOE10#/SHFT_LD# | OEb10_SHFT_LDb | E11 | I | | |
| vOE11# | OEb11 | C11 | I | | |
| vOE12# | OEb12 | B10 | I | | |
| vOE13#/NC | NC | B9 | I | Completing a drop-in replacement does not require any changes on these pins. These pins are NC for both the RC19020 and the LMKDB1120 and can be left floating. LMKDB1120 offers an additional active low OE function for CLK13, CLK14, CLK15, CLK16, CLK17, CLK18 and CLK19. These LMKDB1120 pins have internal pulldown resistors that enable the outputs by default and can be left floating. | |
| vOE14#/NC | NC | B7 | I | | |
| vOE15#/NC | NC | B5 | I | | |
| vOE16#/NC | NC | B3 | I | | |
| vOE17#/NC | NC | D2 | I | | |
| vOE18#/NC | NC | D11 | I | | |
| vOE19#/NC | NC | J11 | I | | |
| Communication | | | | | |
| SBI_OUT/NC | SBI_OUT | C2 | O | No differences. | N/A. |
| SMB_DATA | SDATA | L4 | I/O | | |
| SMB_CLK | SCLK | L5 | I | | |
| vSBI_EN | SBI_ENQ | E2 | I | | |
| ^vSADR1_tr | SADR_tri1 | B8 | I | | |
| ^vSADR0_tr | SADR_tri0 | B4 | I | | |
| Power | | | | | |

| PIN | | | | Pin Differences between RC19020 and LMKDB1120 that Affect Drop-In Replacements | Design Requirements when Replacing the RC19020 with the LMKDB1120 |
|----------------------|--------------|-----|------|---|---|
| TI NAME | RENESAS NAME | NO. | TYPE | | |
| VDDA | VDDR | H2 | P | Completing a drop-in replacement does not require any changes on this pin. The input receiver power supply pin name is different between the RC19020 and the LMKDB1120. TI decided to follow DB2000QL's definition for naming the input receiver power supply pin as <i>VDDA</i> . | No changes are required. Keep the same power filtering used for the RC19020. |
| VDD | VDDCLK | B2 | P | | |
| VDD | VDDCLK | B6 | P | | |
| VDD | VDDCLK | B11 | P | | |
| VDD | VDDCLK | L2 | P | | |
| VDD | VDDCLK | L11 | P | | |
| Miscellaneous | | | | | |
| DAP | EPAD | GND | G | No differences. | N/A. |
| LOS#/NC | LOSb | G11 | O | | |
| NC | NC | F2 | NC | | |
| NC | NC | F11 | NC | | |
| NC | NC | G2 | NC | | |
| NC | NC | L7 | NC | | |
| vPWRGD/PWRDN# | PWRGD_PWRDNb | M6 | I | RC19020 has an internal pullup resistor while LMKDB1120 has an internal pulldown resistor. TI followed DB2000QL's definition which states that the PWRGD/PWRDN# pin requires an internal pulldown resistor. | Do not leave this pin floating and depend on the internal resistor. Drive pin low or high through external controllers, or pull pin low or high through external resistors. |

2.2 RC19020 vs. LMKDB1120 Exposed Registers Comparison

There are no differences between the RC19020 and the LMKDB1120 exposed registers.

3 9QXL2001B vs. LMKDB1120 Comparison

3.1 9QXL2001B vs. LMKDB1120 Pin Comparison

To summarize, no hardware changes are required when replacing the 9QXL2001B with the LMKDB1120.

| PIN | | | | Pin Differences between 9QXL2001B and LMKDB1120 that Affect Drop-In Replacements | Design Requirements when Replacing the 9QXL2001B with the LMKDB1120 |
|---------------|--------------|-----|------|--|---|
| TI NAME | RENESAS NAME | NO. | TYPE | | |
| Input | | | | | |
| CLKIN_P | DIF_IN | G1 | I | No differences. | N/A. |
| CLKIN_N | DIF_IN# | H1 | I | | |
| Output | | | | | |
| CLK0_P | DIF0 | J1 | O | No difference | N/A |
| CLK0_N | DIF0# | K1 | O | | |
| CLK1_P | DIF1 | L1 | O | | |
| CLK1_N | DIF1# | M1 | O | | |
| CLK2_P | DIF2 | M2 | O | | |
| CLK2_N | DIF2# | M3 | O | | |
| CLK3_P | DIF3 | M4 | O | | |
| CLK3_N | DIF3# | M5 | O | | |
| CLK4_P | DIF4 | M7 | O | | |
| CLK4_N | DIF4# | M8 | O | | |
| CLK5_P | DIF5 | M9 | O | | |
| CLK5_N | DIF5# | M10 | O | | |
| CLK6_P | DIF6 | M11 | O | | |
| CLK6_N | DIF6# | M12 | O | | |
| CLK7_P | DIF7 | L12 | O | | |
| CLK7_N | DIF7# | K12 | O | | |
| CLK8_P | DIF8 | J12 | O | | |
| CLK8_N | DIF8# | H12 | O | | |
| CLK9_P | DIF9 | G12 | O | | |
| CLK9_N | DIF9# | F12 | O | | |
| CLK10_P | DIF10 | D12 | O | | |
| CLK10_N | DIF10# | C12 | O | | |
| CLK11_P | DIF11 | B12 | O | | |
| CLK11_N | DIF11# | A12 | O | | |
| CLK12_P | DIF12 | A11 | O | | |
| CLK12_N | DIF12# | A10 | O | | |
| CLK13_P | DIF13 | A9 | O | | |
| CLK13_N | DIF13# | A8 | O | | |
| CLK14_P | DIF14 | A7 | O | | |
| CLK14_N | DIF14# | A6 | O | | |
| CLK15_P | DIF15 | A5 | O | | |
| CLK15_N | DIF15# | A4 | O | | |
| CLK16_P | DIF16 | A3 | O | | |
| CLK16_N | DIF16# | A2 | O | | |
| CLK17_P | DIF17 | A1 | O | | |
| CLK17_N | DIF17# | B1 | O | | |
| CLK18_P | DIF18 | C1 | O | | |

| PIN | | | | Pin Differences between 9QXL2001B and LMKDB1120 that Affect Drop-In Replacements | Design Requirements when Replacing the 9QXL2001B with the LMKDB1120 |
|----------------------|-----------------|-----|------|--|---|
| TI NAME | RENESAS NAME | NO. | TYPE | | |
| CLK18_N | DIF18# | D1 | O | No difference | N/A |
| CLK19_P | DIF19 | E1 | O | | |
| CLK19_N | DIF19# | F1 | O | | |
| Output Enable | | | | | |
| vOE0#/NC | NC | J2 | I | Completing a drop-in replacement does not require any changes on these pins. These pins are NC for both the 9QXL2001B and the LMKDB1120 and can be left floating. LMKDB1120 offers an additional active low OE function for CLK0, CLK1, CLK2, CLK3, and CLK4. These LMKDB1120 pins have internal pulldown resistors that enable the outputs by default and can be left floating. | N/A. |
| vOE1#/NC | NC | K2 | I | | |
| vOE2#/NC | NC | L3 | I | | |
| vOE3#/NC | NC | L6 | I | | |
| vOE4#/NC | NC | L9 | I | | |
| vOE5#/SBI_IN | vOE5#/DATA | L8 | I | | |
| vOE6#/SBI_CLK | vOE6#/CLK | L10 | I | | |
| vOE7# | vOE7# | K11 | I | | |
| vOE8# | vOE8# | H11 | I | Completing a drop-in replacement does not require any changes on these pins. These pins are NC for both the 9QXL2001B and the LMKDB1120 and can be left floating. LMKDB1120 offers an additional active low OE function for CLK13, CLK14, CLK15, CLK16, CLK17, CLK18 and CLK19. These LMKDB1120 pins have internal pulldown resistors that enable the outputs by default and can be left floating. | N/A. |
| vOE9# | vOE9# | E12 | I | | |
| vOE10#/SHFT_LD# | vOE10#/SHFT_LD# | E11 | I | | |
| vOE11# | vOE11# | C11 | I | | |
| vOE12# | vOE12# | B10 | I | | |
| vOE13#/NC | NC | B9 | I | | |
| vOE14#/NC | NC | B7 | I | | |
| vOE15#/NC | NC | B5 | I | | |
| vOE16#/NC | NC | B3 | I | | |
| vOE17#/NC | NC | D2 | I | | |
| vOE18#/NC | NC | D11 | I | | |
| vOE19#/NC | NC | J11 | I | | |
| Communication | | | | | |
| SBI_OUT/NC | NC | C2 | O | Completing a drop-in replacement does not require any changes on these pins. These pins are NC for both the 9QXL2001B and the LMKDB1120 and can be left floating. LMKDB1120 offers an additional SBI data output function. This pin can be left floating since SBI data output pin is optional and only needed when forming a daisy chain topology. | N/A. |
| SMB_DATA | SMBDAT | L4 | I/O | | |
| SMB_CLK | SMBCLK | L5 | I | | |
| vSBI_EN | vSBEN | E2 | I | | |
| ^vSADR1_tr | ^vSADR1_tri | B8 | I | | |
| ^vSADR0_tr | ^vSADR0_tri | B4 | I | | |

| PIN | | | | Pin Differences between 9QXL2001B and LMKDB1120 that Affect Drop-In Replacements | Design Requirements when Replacing the 9QXL2001B with the LMKDB1120 |
|----------------------|--------------|-----|------|--|---|
| TI NAME | RENESAS NAME | NO. | TYPE | | |
| Power | | | | | |
| VDDA | VDDR3.3 | H2 | P | Completing a drop-in replacement does not require any changes on this pin. The input receiver power supply pin name is different between the 9QXL2001B and the LMKDB1120. TI decided to follow DB2000QL's definition for naming the input receiver power supply pin as <i>VDDA</i> . | No changes are required. Keep the same power filtering used for the 9QXL2001B. |
| VDD | VDDO3.3 | B2 | P | No difference | |
| VDD | VDDA3.3 | B6 | P | Completing a drop-in replacement does not require any changes on this pin. This pin name is different between the 9QXL2001B and the LMKDB1120. TI decided to follow DB2000QL's definition which states that the input receiver power supply pin name is <i>VDDA</i> . Pin B6 is not an input receiver power supply pin on the LMKDB1120 and was not labeled as such. | |
| VDD | VDDO3.3 | B11 | P | No differences. | |
| VDD | VDDO3.3 | L2 | P | | |
| VDD | VDDO3.3 | L11 | P | | |
| Miscellaneous | | | | | |
| DAP | EPAD | GND | G | No difference | N/A. |
| LOS#/NC | NC | G11 | O | Completing a drop-in replacement does not require any changes on this pin. These pins are NC for both the 9QXL2001B and the LMKDB1120 and can be left floating. LMKDB1120 offers an additional LOS# function. This pin is open drain and can be left floating. Open drain outputs require an external pullup resistor to close the current path and generate a signal. | |
| NC | NC | F2 | NC | No differences. | |
| NC | NC | F11 | NC | | |
| NC | NC | G2 | NC | | |
| NC | NC | L7 | NC | | |
| vPWRGD/PWRDN# | vCKPWRGD_PD# | M6 | I | | |

3.2 9QXL2001B vs. LMKDB1120 Exposed Register Comparison

Note

IMPORTANT: If following the DB2000QL's definition, then the differences highlighted below do not apply to your application.

To summarize:

- The 9QXL2001B and the LMKDB1120 have the same default global output amplitude but different register writes to obtain other global output amplitudes. Refer to register R20[7:4] to correctly program the LMKDB1120 to the desired global output amplitude.
- The LMKDB1120 does not have differential stop mode state control while the 9QXL2001B does. Do not change the POR default of the LMKDB1120 R20[1:0].

| BYTE | BITS | TI NAME | RENESAS NAME | Register Differences between 9QXL2001B and LMKDB1120 that Affect Drop-In Replacements | Design Requirements when Replacing the 9QXL2001B with the LMKDB1120 |
|------|------|------------------------|----------------------|--|---|
| R0 | 7:0 | Output Enable Controls | Output Enable | No difference | N/A. |
| R1 | 7:0 | | | | |
| R2 | 7:0 | | | | |
| R3 | 7:0 | OE Pin Readback | OE# Pin Readback | | |
| R4 | 7:5 | Reserved | Reserved | No difference | |
| | 4 | AOD Enable Control | Reserved | Completing a drop-in replacement does not require any software changes on this bit. The 9QXL2001B's R4[4] is reserved while the LMKDB1120's R4[4] offers an additional automatic output disable function. The LMKDB1120's default value at POR matches the 9QXL2001B's default. | |
| | 3:1 | Reserved | Reserved | No difference | |
| | 0 | SBI_EN Readback | SBEN Readback | | |
| R5 | 7:0 | Device Info | Vendor & Revision ID | No difference | |
| R6 | 7:0 | Device Info (cont.) | Device ID | | |
| R7 | 7:0 | SMBus Byte Counter | Byte Count | | |
| R8 | 7:0 | SBI Mask | Side Bank Mask | | |
| R9 | 7:0 | | | | |
| R10 | 7:0 | | | | |

| BYTE | BITS | TI NAME | RENESAS NAME | Register Differences between 9QXL2001B and LMKDB1120 that Affect Drop-In Replacements | Design Requirements when Replacing the 9QXL2001B with the LMKDB1120 |
|------|------|----------|--------------|---|---|
| R20 | 7 | AMP_1 | AMP[2] | The 9QXL2001B global differential output control register (20[7:5]) spreads across 3 bits to represent global output amplitudes from 0.3V through 1V in 100mV step. The LMKDB1120 global differential output control register (R20[7:4]) spreads across 4 bits to represent global output amplitudes from 0.6V through 1V in 25mV steps. Both of these parts have the same default global output amplitude at POR of 0.75V. | If not using the default global output amplitude of the 9QXL2001B, program bits R20[7:4] of the LMKDB1120 as follows: 0h = 600mV 1h = 625mV 2h = 650mV 3h = 675mV 4h = 700mV 5h = 725mV 6h = 750mV 7h = 775mV 8h = 800mV 9h = 825mV Ah = 850mV Bh = 875mV Ch = 900mV Dh = 925mV Eh = 950mV Fh = 975mV |
| | 6 | | AMP[1] | | |
| | 5 | | AMP[0] | | |
| | 4 | | Reserved | | |
| | 3:2 | Reserved | Reserved | No difference | N/A. |
| | 1 | Reserved | STOPST[1] | The LMKDB1120 does not have differential stop mode state control like the 9QXL2001B. The default of both parts is the same (set to 0x0 = Low/Low). TI followed DB200QL's definition differential stop mode default which does not require modifications. | Do not program these registers on the LMKDB1120. Leave the POR value of 0x0 unchanged. |
| | 0 | | STOPTS[0] | | |

| BYTE | BITS | TI NAME | RENESAS NAME | Register Differences between 9QXL2001B and LMKDB1120 that Affect Drop-In Replacements | Design Requirements when Replacing the 9QXL2001B with the LMKDB1120 |
|------|------|------------------|--------------|--|---|
| R21 | 7 | RX1_EN_AC_INPUT | Reserved | Completing a drop-in replacement does not require any software changes on these bits. The 9QXL2001B 21[7:6] are reserved and have the same default POR values as the LMKDB1120. The LMKDB1120 R21[7:6] offer additional input functions: enabling a receiver bias when CLKIN1 is AC coupled and enabling an internal 50Ω input termination on CLKIN1. | N/A. |
| | 6 | RX1_EN_RTERM_LSB | | | |
| | 5:4 | Reserved | Reserved | No difference | |
| | 3 | PD_RESTORB | PD_RESTORE# | | |
| | 2 | SDATA_TIMEOUT_EN | Reserved | Completing a drop-in replacement does not require any software changes on this bit. The 9QXL2001B 21[2] is reserved while the LMKDB1120 R21[2] offers an additional SMBus SDATA time out monitoring function. The LMKDB1120's default value at POR matches the 9QXL2001B's default. | |
| | 1 | Reserved | Reserved | No difference | |
| | 0 | LOSb_RB | Reserved | Completing a drop-in replacement does not require any software changes on this bit. The 9QXL2001B's 21[0] is reserved while the LMKDB1120's R21[0] offers an additional readback of LOS detect clock output function. The LMKDB1120's default value at POR matches the 9QXL2001B's default. | |

4 9QXL2001C vs. LMKDB1120 Comparison

4.1 9QXL2001C vs. LMKDB1120 Pin Comparison

To summarize, no hardware changes are required when replacing the 9QXL2001C with the LMKDB1120.

| PIN | | | | Pin Differences between 9QXL2001C and LMKDB1120 that Affect Drop-In Replacements | Design Requirements when Replacing the 9QXL2001C with the LMKDB1120 |
|---------------|--------------|-----|------|--|---|
| TI NAME | RENESAS NAME | NO. | TYPE | | |
| Input | | | | | |
| CLKIN_P | DIF_IN | G1 | I | No differences. | N/A. |
| CLKIN_N | DIF_IN# | H1 | I | | |
| Output | | | | | |
| CLK0_P | DIF0 | J1 | O | No difference | N/A |
| CLK0_N | DIF0# | K1 | O | | |
| CLK1_P | DIF1 | L1 | O | | |
| CLK1_N | DIF1# | M1 | O | | |
| CLK2_P | DIF2 | M2 | O | | |
| CLK2_N | DIF2# | M3 | O | | |
| CLK3_P | DIF3 | M4 | O | | |
| CLK3_N | DIF3# | M5 | O | | |
| CLK4_P | DIF4 | M7 | O | | |
| CLK4_N | DIF4# | M8 | O | | |
| CLK5_P | DIF5 | M9 | O | | |
| CLK5_N | DIF5# | M10 | O | | |
| CLK6_P | DIF6 | M11 | O | | |
| CLK6_N | DIF6# | M12 | O | | |
| CLK7_P | DIF7 | L12 | O | | |
| CLK7_N | DIF7# | K12 | O | | |
| CLK8_P | DIF8 | J12 | O | | |
| CLK8_N | DIF8# | H12 | O | | |
| CLK9_P | DIF9 | G12 | O | | |
| CLK9_N | DIF9# | F12 | O | | |
| CLK10_P | DIF10 | D12 | O | | |
| CLK10_N | DIF10# | C12 | O | | |
| CLK11_P | DIF11 | B12 | O | | |
| CLK11_N | DIF11# | A12 | O | | |
| CLK12_P | DIF12 | A11 | O | | |
| CLK12_N | DIF12# | A10 | O | | |
| CLK13_P | DIF13 | A9 | O | | |
| CLK13_N | DIF13# | A8 | O | | |
| CLK14_P | DIF14 | A7 | O | | |
| CLK14_N | DIF14# | A6 | O | | |
| CLK15_P | DIF15 | A5 | O | | |
| CLK15_N | DIF15# | A4 | O | | |
| CLK16_P | DIF16 | A3 | O | | |
| CLK16_N | DIF16# | A2 | O | | |
| CLK17_P | DIF17 | A1 | O | | |
| CLK17_N | DIF17# | B1 | O | | |
| CLK18_P | DIF18 | C1 | O | | |

| PIN | | | | Pin Differences between 9QXL2001C and LMKDB1120 that Affect Drop-In Replacements | Design Requirements when Replacing the 9QXL2001C with the LMKDB1120 |
|----------------------|-----------------|-----|------|--|---|
| TI NAME | RENESAS NAME | NO. | TYPE | | |
| CLK18_N | DIF18# | D1 | O | No difference | N/A. |
| CLK19_P | DIF19 | E1 | O | | |
| CLK19_N | DIF19# | F1 | O | | |
| Output Enable | | | | | |
| vOE0#/NC | NC | J2 | I | Completing a drop-in replacement does not require any changes on these pins. These pins are NC for both the 9QXL2001C and the LMKDB1120 and can be left floating. LMKDB1120 offers an additional active low OE function for CLK0, CLK1, CLK2, CLK3, and CLK4. These LMKDB1120 pins have internal pulldown resistors that enable the outputs by default and can be left floating. | N/A. |
| vOE1#/NC | NC | K2 | I | | |
| vOE2#/NC | NC | L3 | I | | |
| vOE3#/NC | NC | L6 | I | | |
| vOE4#/NC | NC | L9 | I | | |
| vOE5#/SBI_IN | vOE5#/DATA | L8 | I | No differences | |
| vOE6#/SBI_CLK | vOE6#/CLK | L10 | I | | |
| vOE7# | vOE7# | K11 | I | | |
| vOE8# | vOE8# | H11 | I | | |
| vOE9# | vOE9# | E12 | I | | |
| vOE10#/SHFT_LD# | vOE10#/SHFT_LD# | E11 | I | | |
| vOE11# | vOE11# | C11 | I | | |
| vOE12# | vOE12# | B10 | I | | |
| vOE13#/NC | NC | B9 | I | Completing a drop-in replacement does not require any changes on these pins. These pins are NC for both the 9QXL2001B and the LMKDB1120 and can be left floating. LMKDB1120 offers an additional active low OE function for CLK13, CLK14, CLK15, CLK16, CLK17, CLK18 and CLK19. These LMKDB1120 pins have internal pulldown resistors that enable the outputs by default and can be left floating. | |
| vOE14#/NC | NC | B7 | I | | |
| vOE15#/NC | NC | B5 | I | | |
| vOE16#/NC | NC | B3 | I | | |
| vOE17#/NC | NC | D2 | I | | |
| vOE18#/NC | NC | D11 | I | | |
| vOE19#/NC | NC | J11 | I | | |
| Communication | | | | | |
| SBI_OUT/NC | NC | C2 | O | Completing a drop-in replacement does not require any changes on these pins. These pins are NC for both the 9QXL2001C and the LMKDB1120 and can be left floating. LMKDB1120 offers an additional SBI output function. This pin can be left floating since SBI data output pin is optional and only needed when forming a daisy chain topology. | N/A. |
| SMB_DATA | SMBDAT | L4 | I/O | | |
| SMB_CLK | SMBCLK | L5 | I | | |
| vSBI_EN | vSBEN | E2 | I | | |
| ^vSADR1_tr | ^vSADR1_tri | B8 | I | | |
| ^vSADR0_tr | ^vSADR0_tri | B4 | I | No differences. | |

| PIN | | | | Pin Differences between 9QXL2001C and LMKDB1120 that Affect Drop-In Replacements | Design Requirements when Replacing the 9QXL2001C with the LMKDB1120 |
|----------------------|--------------|-----|------|--|--|
| TI NAME | RENESAS NAME | NO. | TYPE | | |
| Power | | | | | |
| VDDA | VDDR3.3 | H2 | P | Completing a drop-in replacement does not require any changes on this pin. The input receiver power supply pin name is different between the 9QXL2001C and the LMKDB1120. TI decided to follow DB2000QL's definition for naming the input receiver power supply pin as <i>VDDA</i> . | No changes are required. Keep the same power filtering used for the 9QXL2001C. |
| VDD | VDDO3.3 | B2 | P | No difference | |
| VDD | VDDA3.3 | B6 | P | Completing a drop-in replacement does not require any changes on this pin. This pin name is different between the 9QXL2001C and the LMKDB1120. TI decided to follow DB2000QL's definition for naming the input receiver power supply pin as <i>VDDA</i> . Pin B6 is not an input receiver power supply pin on the LMKDB1120 and was not labeled as such. | |
| VDD | VDDO3.3 | B11 | P | No differences. | |
| VDD | VDDO3.3 | L2 | P | | |
| VDD | VDDO3.3 | L11 | P | | |
| Miscellaneous | | | | | |
| DAP | EPAD | GND | G | No difference | N/A. |
| LOS#/NC | NC | G11 | O | Completing a drop-in replacement does not require any changes on this pin. These pins are NC for both the 9QXL2001C and the LMKDB1120 and can be left floating. LMKDB1120 offers an additional LOS# function. This pin is open drain and can be left floating. Open drain outputs require an external pullup resistor to close the current path and generate a signal. | |
| NC | NC | F2 | NC | No differences. | |
| NC | NC | F11 | NC | | |
| NC | NC | G2 | NC | | |
| NC | NC | L7 | NC | | |
| vPWRGD/PWRDN# | vCKPWRGD_PD# | M6 | I | | |

4.2 9QXL2001C vs. LMKDB1120 Exposed Registers Comparison

Note

IMPORTANT: If following the DB2000QL's definition, then the differences highlighted below do not apply to your application.

To summarize, if the 9QXL2001C's default global output amplitude is required, then program R20[7:4] = 7 in the LMKDB1120 to get the same global output amplitude value of 0.775V.

| BYTE | BITS | TI NAME | RENESAS NAME | Register Difference between 9QXL2001C and LMKDB1120 that Affect Drop-In Replacements | Design Requirements when Replacing the 9QXL2001C with the LMKDB1120 |
|------|------|------------------------|----------------------|--|--|
| R0 | 7:0 | Output Enable Controls | Output Enable | No difference | N/A. |
| R1 | 7:0 | | | | |
| R2 | 7:0 | | | | |
| R3 | 7:0 | OE Pin Readback | OE# Pin Readback | | |
| R4 | 7:5 | Reserved | Reserved | No difference | |
| | 4 | AOD Enable Control | Reserved | Completing a drop-in replacement does not require any software changes on this bit. The 9QXL2001C's 4[4] is reserved while the LMKDB1120's R4[4] offers an additional automatic output disable function. | |
| | 3:1 | Reserved | Reserved | No difference | |
| | 0 | SBI_EN Readback | SBEN Readback | | |
| R5 | 7:0 | Device Info | Vendor & Revision ID | No difference | |
| R6 | 7:0 | Device Info (cont.) | Device ID | | |
| R7 | 7:0 | SMBus Byte Counter | Byte Count | | |
| R8 | 7:0 | SBI Mask | Side Bank Mask | | |
| R9 | 7:0 | | | | |
| R10 | 7:0 | | | | |
| R20 | 7 | AMP_1 | AMP[3] | 9QXL2001C 20[7:4] default is 0x7h (or 0.775V global output amplitude) while the LMKDB1120's R20[7:4] default is 0x6h (or 0.75V global output amplitude). The default global output amplitude bit assignments are the same between the 9QXL2001C and the LMKDB1120. | Program 0x7h to R20[7:4] of the LMKDB1120 to get the default global output amplitude value of the 9QXL2001C (or 0.775V). |
| | 6 | | AMP[2] | | |
| | 5 | | AMP[1] | | |
| | 4 | | AMP[0] | | |
| | 3:0 | Reserved | Reserved | No difference | |

| BYTE | BITS | TI NAME | RENESAS NAME | Register Difference between 9QXL2001C and LMKDB1120 that Affect Drop-In Replacements | Design Requirements when Replacing the 9QXL2001C with the LMKDB1120 |
|------|---------|--|--------------|---|---|
| R21 | 7 | RX1_EN_AC_INPUT | Reserved | Completing a drop-in replacement does not require any software changes on these bits. The 9QXL2001C 21[7:6] are reserved and have the same default POR value as the LMKDB1120. The LMKDB1120 R21[7:6] offer additional input functions: enabling a receiver bias when CLKIN1 is AC coupled and enabling an internal 50Ω input termination on CLKIN1. | N/A. |
| | 6 | RX1_EN_RTERM_LSB | | | |
| | 5:4 | Reserved | Reserved | No difference | |
| | 3 | PD_RESTORB | PD_RESTORE# | | |
| | 2 | SDATA_TIMEOUT_EN | Reserved | Completing a drop-in replacement does not require any software changes on this bit. The 9QXL2001C 21[2] is reserved while the LMKDB1120 R21[2] offers an additional SMBus SDATA time out monitoring function. The LMKDB1120's default value at POR matches the 9QXL2001C's default. | |
| | 1 | Reserved | | No difference | |
| 0 | LOSb_RB | Completing a drop-in replacement does not require any software changes on this bit. The 9QXL2001C's 21[0] is reserved while the LMKDB1120's R21[0] offers an additional readback of LOS detect clock output function. The LMKDB1120's default value at POR matches the 9QXL2001C's default. | | | |

5 CDCDB2000 vs. LMKDB1120 Comparison

There are no pin or exposed register differences between the LMKDB1120 and the CDCDB2000. Both parts can be dropped-in for one another with no changes required.

6 RC19008 vs. LMKDB1108 Comparison

6.1 RC19008 vs. LMKDB1108 Pin Comparison

To summarize, when replacing the RC19008 with the LMKDB1108:

- When SBI is disabled, do not leave OE pins floating and depend on the internal pulldown resistors of the OE pins. Instead, drive OE pins low or high through external controllers, or pull OE pins low or high through external resistors.
- Do not leave the vPWRGD/PWRDN# pin (12) floating and depend on the internal pulldown resistor on the LMKDB1108. Instead, drive pin 12 low or high through external controllers, or pull pin 12 low or high through external resistors.

| PIN | | | | Pin Differences between RC19008 and LMKDB1108 that Affect Drop-In Replacements | Design Requirements when Replacing the RC19008 with the LMKDB1108 | | |
|----------------------|----------------|-----|------|--|---|--|-----------------|
| TI NAME | RENESAS NAME | NO. | TYPE | | | | |
| Input | | | | | | | |
| CLKIN_P | CLKIN | 8 | I | No difference | N/A. | | |
| CLKIN_N | CLKINb | 9 | I | | | | |
| Output | | | | | | | |
| CLK0_P | CLK13 | 15 | O | No difference | N/A. | | |
| CLK0_N | CLKb13 | 16 | O | | | | |
| CLK1_P | CLK10 | 17 | O | | | | |
| CLK1_N | CLKb10 | 18 | O | | | | |
| CLK2_P | CLK7 | 22 | O | | | | |
| CLK2_N | CLKb7 | 23 | O | | | | |
| CLK3_P | CLK6 | 24 | O | | | | |
| CLK3_N | CLKb6 | 25 | O | | | | |
| CLK4_P | CLK5 | 28 | O | | | | |
| CLK4_N | CLKb5 | 29 | O | | | | |
| CLK5_P | CLK3 | 31 | O | | | | |
| CLK5_N | CLKb3 | 32 | O | | | | |
| CLK6_P | CLK2 | 35 | O | | | | |
| CLK6_N | CLKb2 | 36 | O | | | | |
| CLK7_P | CLK1 | 38 | O | | | | |
| CLK7_N | CLKb1 | 39 | O | | | | |
| Output Enable | | | | | | | |
| vOE0#/SHFT_LD# | OEb13_SHFT_LDb | 14 | I | OE mode | SBI Mode | OE mode | SBI Mode |
| vOE1#/SBI_IN | OEb10_SBI_IN | 19 | I | RC19008 has an internal pullup resistor while LMKDB1108 has an internal pulldown resistor. TI decided to follow DB2000QL's definition which states that the OE pins require internal pulldown resistors. | No difference | Do not leave these pins floating and depend on the internal resistors. Drive OE pins low or high through external controllers, or pull OE pins low or high through external resistors. | N/A. |

| PIN | | | | Pin Differences between RC19008 and LMKDB1108 that Affect Drop-In Replacements | Design Requirements when Replacing the RC19008 with the LMKDB1108 | | |
|----------------------|--------------|-----|------|---|---|---|-----------------|
| TI NAME | RENESAS NAME | NO. | TYPE | | OE mode | SBI Mode | OE mode |
| vOE2# | OEb7 | 21 | I | RC19008 has an internal pullup resistor while LMKDB1108 has an internal pulldown resistor. TI decided to follow DB2000QL's definition as a guideline which states that the OE pins require internal pulldown resistors. | | Do not leave these pins floating and depend on the internal resistor. Drive OE pins low or high through external controllers, or pull OE pins low or high through external resistors. | |
| vOE3# | OEb6 | 27 | I | | | | |
| vOE4#/SBI_CLK | OEb5_SBI_CLK | 30 | I | OE mode | SBI Mode | OE mode | SBI Mode |
| | | | | RC19008 has an internal pullup resistor while LMKDB1108 has an internal pulldown resistor. TI decided to follow DB2000QL's definition as a guideline which states that the OE pins require internal pulldown resistors. | No difference | Do not leave this pin floating and depend on the internal pulldown resistor of the LMKDB1108. Drive OE pin low or high through external controllers, or pull OE pin low or high through external resistors. | N/A. |
| vOE5# | OEb3 | 33 | I | RC19008 has an internal pullup resistor while LMKDB1108 has an internal pulldown resistor. TI decided to follow DB2000QL's definition as a guideline which states that the OE pins require internal pulldown resistors. | | Do not leave this pin floating and depend on the internal resistor. Drive OE pin low or high through external controllers, or pull OE pin low or high through external resistors. | |
| vOE6#/SBI_OUT | OEb2_SBI_OUT | 34 | I | OE mode | SBI Mode | OE mode | SBI Mode |
| | | | | RC19008 has an internal pullup resistor while LMKDB1108 has an internal pulldown resistor. TI decided to follow DB2000QL's definition which states that the OE pins require internal pulldown resistors. | No difference | Do not leave this pin floating and depend on the internal resistor. Drive OE pin low or high through external controllers, or pull OE pin low or high through external resistors. | N/A. |
| vOE7# | OEb1 | 40 | I | RC19008 has an internal pullup resistor while LMKDB1108 has an internal pulldown resistor. TI decided to follow DB2000QL's definition which states that the OE pins require internal pulldown resistors. | | Do not leave this pin floating and depend on the internal resistor. Drive OE pin low or high through external controllers, or pull OE pin low or high through external resistors. | |
| Communication | | | | | | | |
| SMB_DATA | SDATA | 5 | I/O | No difference | | N/A. | |
| SMB_CLK | SCLK | 6 | I | | | | |
| vSBI_EN | SBI_ENQ | 11 | I | | | | |
| ^vSADR1_tri | SADR_tri1 | 3 | I | | | | |
| ^vSADR0_tri | SADR_tri0 | 4 | I | | | | |
| Power | | | | | | | |

| PIN | | | | Pin Differences between RC19008 and LMKDB1108 that Affect Drop-In Replacements | Design Requirements when Replacing the RC19008 with the LMKDB1108 |
|----------------------|--------------|--------|------|---|--|
| TI NAME | RENESAS NAME | NO. | TYPE | | |
| VDDA | VDDDIG | 7 | P | <p>Completing a drop-in replacement does not require any changes on this pin.</p> <p>Pin name and function are different between the RC19008 and the LMKDB1108. TI decided to have an input receiver power supply pin to follow DB2000QL's definition as a guideline and name this pin according to this definition. DB2000QL's definition establishes this pin's name as <i>VDDA</i>. Renesas does not seem to be following DB2000QL's definition and do not have an input receiver power supply pin for the RC19008.</p> | <p>No changes are required. Keep the same power filtering used for the RC19008.</p> |
| VDD | VDDCLK | 10 | P | No difference | |
| VDD | VDDCLK | 13 | P | | |
| VDD | VDDCLK | 20 | P | | |
| VDD | VDDCLK | 26 | P | | |
| VDD | VDDCLK | 37 | P | | |
| Miscellaneous | | | | | |
| DAP | EPAD | GND/41 | G | No difference | N/A. |
| LOS# | LOSb | 1 | O | | |
| ^SLEWRATE_SEL | SLEWRATE_SEL | 2 | I | | |
| vPWRGD/PWRDN# | PWRGD_PWRDNb | 12 | I | <p>RC19008 has an internal pullup resistor while LMKDB1108 has an internal pulldown resistor. TI followed DB2000QL's definition as a guideline which states that the PWRGD/PWRDN# pin requires an internal pulldown resistor.</p> | <p>Do not leave this pin floating and depend on the internal resistor. Drive pin low or high through external controllers, or pull pin low or high through external resistors.</p> |

6.2 RC19008 vs. LMKDB1108 Exposed Registers Comparison

Slew rate can be controlled through pin 2, the SLEWRATE_SEL pin, or through software for both the RC19008 and the LMKDB1108; therefore, a logic priority needs to exist. Renesas does not define the logic priority used for the RC19008 or exposes the slew rate selection register. Therefore, TI assumed this as a difference between the RC19008 and the LMKDB1108.

The [LMKDB1108 Data Sheet](#) under the *LMKDB1108 Registers* section has more information about this register, R53[5] or SLEWRATE_CTRL_MODE.

7 RC19004 vs. LMKDB1104 Comparison

7.1 RC19004 vs. LMKDB1104 Pin Comparison

To summarize, when replacing the RC19004 with the LMKDB1104:

- When SBI is enabled, do not leave any SBI pins floating and depend on the internal pulldown resistors of these pins of the LMKDB1104. Instead, drive SBI pins low or high through external controllers, or pull SBI pins low or high through external resistors.
- Do not leave the vPWRGD/PWRDN# pin (9) floating and depend on the internal pulldown resistor on the LMKDB1104. Instead, drive pin 9 low or high through external controllers, or pull pin 9 low or high through external resistors.

| PIN | | | | Pin Differences between RC19004 and LMKDB1104 that Affect Drop-In Replacements | | Design Requirements when Replacing the RC19004 with the LMKDB1104 | |
|---------------------------------|----------------|-----|------|--|---|---|---|
| TI NAME | RENESAS NAME | NO. | TYPE | | | | |
| Input | | | | | | | |
| CLKIN_P | CLKIN | 6 | I | No difference | | N/A | |
| CLKIN_N | CLKINb | 7 | I | | | | |
| Output and Output Enable | | | | | | | |
| CLK0_P | CLK13 | 12 | O | No difference | | N/A. | |
| CLK0_N | CLKb13 | 13 | O | | | | |
| CLK1_P | CLK9 | 16 | O | | | | |
| CLK1_N | CLKb9 | 17 | O | | | | |
| CLK2_P | CLK5 | 19 | O | | | | |
| CLK2_N | CLKb5 | 20 | O | | | | |
| CLK3_P | CLK2 | 23 | O | | | | |
| CLK3_N | CLKb2 | 24 | O | | | | |
| vOE0#/SHFT_LD# | OEb13_SHFT_LD# | 11 | I | OE mode | SBI mode | OE mode | SBI mode |
| vOE1#/SBI_IN | OEb9_SBI_IN | 14 | I | No difference | RC19004 has an internal pullup resistor while LMKDB1104 has an internal pulldown resistor. TI decided to follow DB2000QL's definition as a guideline which states that the OE pins require internal pulldown resistors. | N/A. | Do not leave these pin floating and depend on the internal resistors. Drive SBI pins low or high through external controllers, or pull SBI pins low or high through external resistors. |
| vOE2#/SBI_CLK | OEb5_SBI_CLK | 21 | I | | | | |
| vOE3#/SBI_OUT | OEb2_SBI_OUT | 22 | I | No difference | | N/A. | |
| Power | | | | | | | |

| PIN | | | | Pin Differences between RC19004 and LMKDB1104 that Affect Drop-In Replacements | Design Requirements when Replacing the RC19004 with the LMKDB1104 |
|----------------------|--------------|--------|------|---|---|
| TI NAME | RENESAS NAME | NO. | TYPE | | |
| VDDA | VDDDIG | 5 | P | Completing a drop-in replacement does not require any changes on this pin. The input receiver power supply pin name and function are different between the RC19004 and the LMKDB1104. TI decided to follow DB2000QL's definition for naming the input receiver power supply pin as <i>VDDA</i> . | No changes are required. Keep the same power filtering used for the RC19004. |
| VDD | VDDCLK | 10 | P | | |
| VDD | VDDCLK | 15 | P | | |
| VDD | VDDCLK | 18 | P | | |
| VDD | VDDCLK | 25 | P | | |
| Miscellaneous | | | | | |
| ^vSADR1_tri | SADR_tri1 | 1 | I | No difference | N/A. |
| ^vSADR0_tri | SADR_tri0 | 2 | I | | |
| SMB_DATA | SDATA | 3 | I/O | | |
| SMB_CLK | SCLK | 4 | I | | |
| vSBI_EN | SBI_ENQ | 8 | I | | |
| vPWRGD/PWRDN# | PWRGD_PWRDNb | 9 | I | RC19004 has an internal pullup resistor while LMKDB1104 has an internal pulldown resistor. TI followed DB2000QL's definition as a guideline which states that the PWRGD/PWRDN# pin needs to have an internal pulldown resistor. | Do not leave this pin floating and depend on the internal resistor. Drive pin low or high through external controllers, or pull pin low or high through external resistors. |
| NC | NC | 26 | NC | No difference | N/A. |
| ^SLEWRATE_SEL | SLEWRATE_SEL | 27 | I | | |
| LOS# | LOSb | 28 | O | | |
| GND | EPAD | DAP/29 | G | | |

7.2 RC19004 vs. LMKDB1104 Exposed Register Comparison

There are no differences between the RC19004 and the LMKDB1104 exposed registers.

8 RC19204 vs. LMKDB1204 Comparison

8.1 RC19204 vs. LMKDB1204 Pin Comparison

To summarize, when replacing the RC19204 with the LMKDB1204, do not leave the vPWRGD/PWRDN# pin (1) floating and depend on the internal pulldown resistor on the LMKDB1204. Instead, drive pin 1 low or high through external controllers, or pull pin 1 low or high through external resistors.

| PIN | | | | Pin Differences between RC19204 and LMKDB1204 that Affect Drop-In Replacements | Design Requirements when Replacing the RC19204 with the LMKDB1204 |
|---------------------------------|--------------|-----|------|---|---|
| TI NAME | RENESAS NAME | NO. | TYPE | | |
| Input | | | | | |
| CLKIN0_P | CLKIN0 | 2 | I | No difference | N/A |
| CLKIN0_N | CLKINb0 | 3 | I | | |
| CLKIN1_P | CLKIN1 | 5 | I | | |
| CLKIN1_N | CLKINb1 | 6 | I | | |
| Output and Output Enable | | | | | |
| CLK3_P | CLK12 | 10 | O | No difference | N/A. |
| CLK3_N | CLKb12 | 11 | O | | |
| CLK2_P | CLK10 | 13 | O | | |
| CLK2_N | CLKb10 | 14 | O | | |
| CLK1_P | CLK5 | 20 | O | | |
| CLK1_N | CLKb5 | 21 | O | | |
| CLK0_P | CLK3 | 23 | O | | |
| CLK0_N | CLKb3 | 24 | O | | |
| ^OE3#/SMB_CLK | OEb_G | 9 | I | Completing a drop-in replacement does not require any changes on these pins. This pin is active low OE for both the RC19204 and the LMKDB1204. The LMKDB1204 offers an additional SMBus functionality. When SMBus is enabled, this pin serves as the SMBus clock. | N/A. |
| ^OE2# | OEb_F | 16 | I | No difference | N/A. |
| ^OE1# | OEb_C | 19 | I | | |
| ^OE0# | OEb_B | 25 | I | | |
| Power | | | | | |
| VDD_IN0 | VDDIN0 | 4 | P | No difference | No changes are required. Keep the same power filtering used for the RC19204. |
| VDD_IN1 | VDDINI1 | 7 | P | | |
| VDD_BANK1 | VDDCLK_1 | 12 | P | | |
| VDD_BANK0 | VDDCLK_0 | 22 | P | | |
| VDD_DIG | VDDDIG | 26 | P | | |
| VDDA | VDDA | 18 | P | | |
| Miscellaneous | | | | | |
| vPWRGD/PWRDN# | PWRGD_PWRDNb | 1 | I | RC19204 has an internal pullup resistor while LMKDB1204 has an internal pulldown resistor. TI followed DB2000QL's definition as a guideline which states that the PWRGD/PWRDN# pin needs to have an internal pulldown resistor. | Do not leave this pin floating and depend on the internal resistor. Drive pin low or high through external controllers, or pull pin low or high through external resistors. |

| PIN | | | | Pin Differences between RC19204 and LMKDB1204 that Affect Drop-In Replacements | Design Requirements when Replacing the RC19204 with the LMKDB1204 |
|------------------------------|--------------|--------|------|--|---|
| TI NAME | RENESAS NAME | NO. | TYPE | | |
| ^vCLKIN_SEL_tri/ SMB_DATA | CLKSEL_tri | 8 | I | Completing a drop-in replacement does not require any changes on these pins. This pin is the CLKIN_SEL_tri for both the RC19204 and the LMKDB1204. The LMKDB1204 offers an additional SMBus functionality. When SMBus is enabled, this pin serves as the SMBus data. | N/A. |
| vSMB_EN | DNC | 15 | I | Completing a drop-in replacement does not require any changes on these pins. These pins are NC for both the RC19204 and the LMKDB1204 and can be left floating. LMKDB1204 offers an additional SMBus functionality. This pin has an internal pulldown resistor that disables SMBus by default. | N/A. |
| LOS# | LOSb | 17 | O | No difference | |
| GND | GNDSUB | 27 | G | | |
| vZOUT_SEL | ZOUTSEL | 28 | I | | |
| GND | EPAD | DAP/29 | G | | |

8.2 RC19204 vs. LMKDB1204 Exposed Register Comparison

No comparison can be completed between the RC19204 vs. the LMKDB1204 because Renesas does not expose any registers for the RC19204.

9 RC19202 vs. LMKDB1202 Comparison

9.1 RC19202 vs. LMKDB1202 Pin Comparison

To summarize, OE1# pin (15) needs to receive a certain slew rate to certify the part behaves as expected ($\geq 0.1\text{V/ns}$). To do that, pin 15 cannot see a resistance higher than $1\text{k}\Omega$. Make sure the internal resistance of the component driving the LMKDB1202 and any other series resistance on pin 15 are below $1\text{k}\Omega$.

| PIN | | | | Pin Differences between RC19202 and LMKDB1202 that Affect Drop-In Replacements | Design Requirements when Replacing the RC19202 with the LMKDB1202 |
|---------------------------------|--------------|--------|------|---|--|
| TI NAME | RENESAS NAME | NO. | TYPE | | |
| Input | | | | | |
| CLKIN0_P | CLKIN0 | 1 | I | No difference | N/A. |
| CLKIN0_N | CLKINb0 | 2 | I | | |
| CLKIN1_P | CLKIN1 | 4 | I | | |
| CLKIN1_N | CLKINb1 | 5 | I | | |
| Output and Output Enable | | | | | |
| CLK2_P | CLK10 | 9 | O | No difference | N/A. |
| CLK2_N | CLKb10 | 10 | O | | |
| CLK1_P | CLK5 | 16 | O | | |
| CLK1_N | CLKb5 | 17 | O | | |
| ^OE2# | OEb_F | 12 | I | | |
| ^OE1# | OEb_C | 15 | I | This pin needs to receive a certain slew rate ($\geq 0.1\text{V/ns}$) to certify the LMKDB1202 behaves as expected. To do that, this pin cannot see a resistance higher than $1\text{k}\Omega$. Renesas does not mention this pin having this requirement in the RC19202 data sheet, so TI assumed this as a difference between the RC19202 and the LMKDB1202. | Make sure the internal resistance of the component driving the LMKDB1202 and any other series resistance on this pin are $\leq 1\text{k}\Omega$. In most applications, slew rate requirements are generally met and this is not an issue. |
| Power | | | | | |
| VDD_IN0 | VDDIN0 | 3 | P | No difference | No changes are required. Keep the same power filtering used for the RC19202. |
| VDD_IN1 | VDDIN1 | 6 | P | | |
| VDD_BANK1 | VDDCLK_1 | 8 | P | | |
| VDD_DIG | VDDDIG | 19 | P | | |
| VDD_BANK0 | VDDCLK_0 | 18 | P | | |
| VDDA | VDDA | 14 | P | | |
| Miscellaneous | | | | | |
| ^vCLKIN_SEL_tri | CLKSEL_tri | 7 | I | No difference | N/A. |
| vZOUT_SEL | ZOUTSEL | 11 | I | | |
| LOS# | LOSb | 13 | O | | |
| GND | GNDSUB | 20 | G | | |
| GND | EPAD | DAP/21 | G | | |

9.2 RC19202 vs. LMKDB1202 Exposed Registers Comparison

No comparison can be completed between the RC19202 vs. the LMKDB1202 because neither Renesas nor TI expose any registers.

10 RC19002 vs. LMKDB1102 Comparison

10.1 RC19002 vs. LMKDB1102 Pin Comparison

To summarize, when replacing the RC19002 with the LMKDB1102:

- OE1# pin (15) needs to receive a certain slew rate to certify the part behaves as expected ($\geq 0.1V/ns$). To do that, pin 15 cannot see a resistance higher than $1k\Omega$. Make sure the internal resistance of the component driving the LMKDB1102 and any other series resistance are below $1k\Omega$.
- Do not leave pin 7 (GND) floating. Tie this pin to GND.

| PIN | | | | Pin Differences between RC19002 and LMKDB1102 that Affect Drop-In Replacements | Design Requirements when Replacing the RC19002 with the LMKDB1102 |
|---------------------------------|--------------|-----|------|--|---|
| TI NAME | RENESAS NAME | NO. | TYPE | | |
| Input | | | | | |
| CLKIN_P | CLKIN0 | 1 | I | No difference | N/A |
| CLKIN_N | CLKINb0 | 2 | I | | |
| Output and Output Enable | | | | | |
| CLK2_P | CLK10 | 9 | O | No difference | N/A |
| CLK2_N | CLKb10 | 10 | O | | |
| CLK1_P | CLK5 | 16 | O | | |
| CLK1_N | CLKb5 | 17 | O | | |
| ^OE2# | OEb10 | 12 | I | | |
| ^OE1# | OEb5 | 15 | I | This pin needs to receive a certain slew rate to certify the part behaves as expected ($\geq 0.1V/ns$). To do that, this pin cannot see a resistance higher than $1k\Omega$. Renesas does not mention this pin having this requirement in the RC19002 data sheet, so TI assumed this as a difference between the RC19002 and the LMKDB1102. | Make sure the internal resistance of the component driving the LMKDB1102 and any other series resistance on this pin are $\leq 1k\Omega$. In most applications, slew rate requirements are generally met and this is not an issue. |
| Power | | | | | |
| VDDA | VDDCLK/DNC | 6 | P | Completing a drop-in replacement does not require any changes on this pin. The RC19002 pin is both a NC pin and a power supply pin while the LMKDB1102 pin is only a power supply pin. TI recommends to connect this pin to VDD. This recommendation can be disregarded for drop-in replacements. | No changes are required. Keep the same power filtering used for the RC19002. |
| VDD | VDDCLK | 3 | P | No difference | |
| VDD | VDDCLK | 8 | P | | |
| VDD | VDDCLK | 14 | P | | |
| VDD | VDDCLK | 18 | P | | |
| VDD | VDDDIG | 19 | P | | |
| Miscellaneous | | | | | |
| NC | NC | 4 | I | No difference | N/A. |
| NC | NC | 5 | I | | |

| PIN | | | | Pin Differences between RC19002 and LMKDB1102 that Affect Drop-In Replacements | Design Requirements when Replacing the RC19002 with the LMKDB1102 |
|-----------|--------------|--------|--------|---|---|
| TI NAME | RENESAS NAME | NO. | TYPE | | |
| GND | GND/DNC | 7 | I or G | This pin on the RC19002 is both a NC pin and a GND pin so the pin can either be left floating or connected to GND while this pin on the LMKDB1102 is only a GND pin. TI is unable to tie this pin to DAP/GND inside the package without causing any reliability concerns. | Do not leave this pin floating. Tie this pin to GND. |
| vZOUT_SEL | ZOUTSEL | 11 | I | No difference | N/A. |
| LOS# | LOSb | 13 | O | | |
| GND | GNDSUB | 20 | G | | |
| GND | EPAD | DAP/21 | G | | |

10.2 RC19002 vs. LMKDB1102 Exposed Registers Comparison

No comparison can be completed between the RC19002 vs. the LMKDB1102 because neither Renesas nor TI expose any registers.

11 Summary

The RC19xxx/9QXL2001x device families and the LMKDB1xxx/CDCDB2000 device families have the same pin-outs for each respective comparison. However, there are a few design differences for certain pins between the compatible parts that require changes to complete a drop-in replacement to not affect proper operation. The specific requirements and differences are highlighted in this document.

12 References

- Texas Instruments, [LMKDB1xxx PCIe Gen 1 to Gen 6 Ultra Low Jitter 1:20, 1:8, 1:4, 1:2, 2:4, 2:2 LP-HCSL Clock Buffer and Clock MUX](#), data sheet.
- Renesas, [RC190xx](#), data sheet.
- Renesas, [RC192xx](#), data sheet.

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